



**THE DATASHEET OF
LW A673-Q2R2-KKLL-0-10-R33-Z-VIS**



LW A673

SIDELED®



Applications

- Cluster, Button Backlighting
- Electronic Equipment
- Interior Illumination (e.g. Ambient Map)

Features:

- Package: white SMT package, colored diffused resin
- Chip technology: InGaN
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.33, Cy = 0.33 acc. to CIE 1931 (• white)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ I_v	Ordering Code
LW A673-P1S1-FKPL	45 ... 224 mcd	Q65111A2075

Maximum Ratings

Parameter	Symbol		Values
Reverse voltage			
Reverse voltage			
Operating Temperature	T_{op}	min. max.	-40 °C 100 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 100 °C
Junction Temperature	T_j	max.	110 °C
Forward Current $T_s = 25\text{ °C}$	I_F	max.	20 mA
Surge Current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_s = 25\text{ °C}$	I_{FS}	max.	200 mA
Reverse voltage ²⁾ $T_s = 25\text{ °C}$	V_R	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV

Characteristics

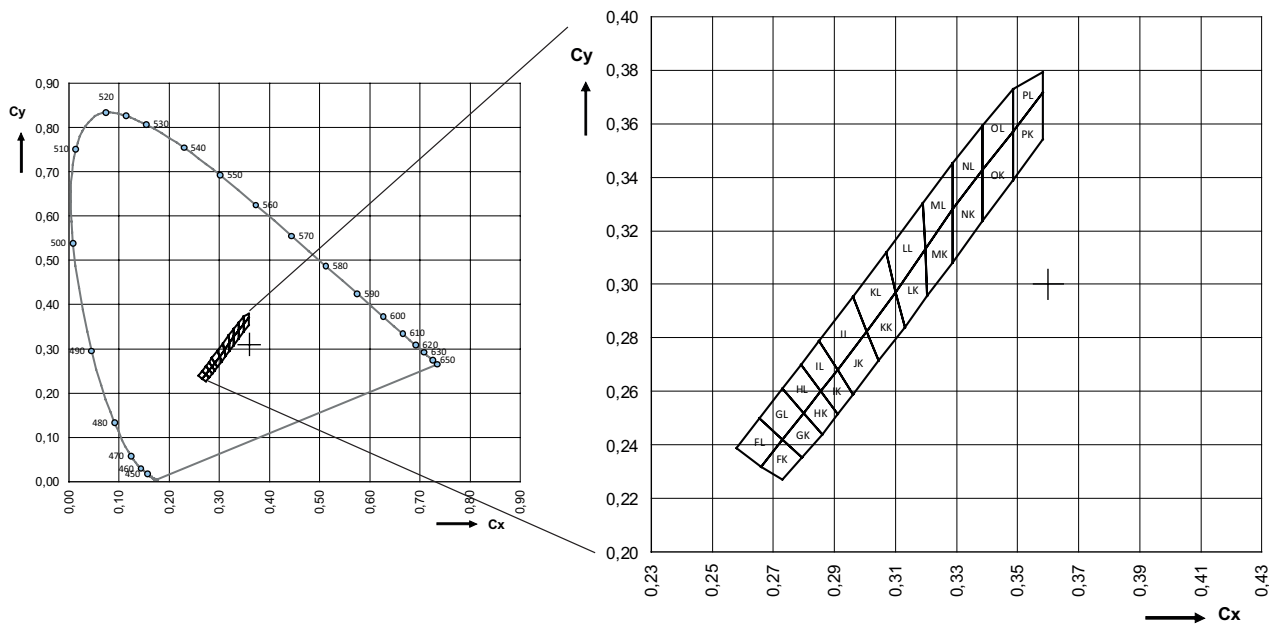
$I_F = 10 \text{ mA}$; $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Reverse current			
Reverse current			
Chromaticity Coordinate ³⁾	Cx	typ.	0.33
	Cy	typ.	0.33
Viewing angle at 50% I_V	2ϕ	typ.	120 °
Forward Voltage ⁴⁾	V_F	min.	2.70 V
$I_F = 10 \text{ mA}$		typ.	3.10 V
		max.	3.40 V
Reverse current ²⁾	I_R	typ.	0.01 μA
$V_R = 5 \text{ V}$		max.	10 μA
Real thermal resistance junction/ambient ⁵⁾⁶⁾	$R_{\text{thJA real}}$	max.	430 K / W
Real thermal resistance junction/solderpoint ⁵⁾	$R_{\text{thJS real}}$	max.	200 K / W

Brightness Groups

Group	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ min. I_v	Luminous Intensity ¹⁾ $I_F = 10 \text{ mA}$ max. I_v	Luminous Flux ⁷⁾ $I_F = 10 \text{ mA}$ typ. Φ_v
P1	45 mcd	56 mcd	150 mlm
P2	56 mcd	71 mcd	190 mlm
Q1	71 mcd	90 mcd	240 mlm
Q2	90 mcd	112 mcd	300 mlm
R1	112 mcd	140 mcd	380 mlm
R2	140 mcd	180 mcd	480 mlm
S1	180 mcd	224 mcd	610 mlm

Chromaticity Coordinate Groups ³⁾



Chromaticity Coordinate Groups ³⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
FK	0.2730	0.2270	HK	0.2860	0.2440	JK	0.2960	0.2590
	0.2660	0.2320		0.2800	0.2520		0.2910	0.2680
	0.2730	0.2420		0.2855	0.2600		0.3005	0.2825
	0.2795	0.2355		0.2910	0.2515		0.3045	0.2715
FL	0.2660	0.2320	HL	0.2800	0.2520	JL	0.2910	0.2680
	0.2580	0.2390		0.2730	0.2610		0.2850	0.2790
	0.2655	0.2500		0.2790	0.2700		0.2960	0.2955
	0.2730	0.2420		0.2855	0.2600		0.3005	0.2825
GK	0.2795	0.2355	IK	0.2910	0.2515	KK	0.3045	0.2715
	0.2730	0.2420		0.2855	0.2600		0.3005	0.2825
	0.2800	0.2520		0.2910	0.2680		0.3100	0.2970
	0.2860	0.2440		0.2960	0.2590		0.3130	0.2840
GL	0.2730	0.2420	IL	0.2855	0.2600	KL	0.3005	0.2825
	0.2655	0.2500		0.2790	0.2700		0.2960	0.2955
	0.2730	0.2610		0.2850	0.2790		0.3070	0.3120
	0.2800	0.2520		0.2910	0.2680		0.3100	0.2970

Not for new design

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
LK	0.3100	0.2970	NK	0.3288	0.3081	PK	0.3484	0.3388
	0.3197	0.3131		0.3288	0.3282		0.3484	0.3571
	0.3205	0.2956		0.3386	0.3426		0.3582	0.3715
	0.3130	0.2840		0.3386	0.3235		0.3582	0.3542
LL	0.3070	0.3120	NL	0.3288	0.3282	PL	0.3484	0.3571
	0.3189	0.3302		0.3288	0.3453		0.3484	0.3730
	0.3197	0.3131		0.3386	0.3591		0.3582	0.3792
	0.3100	0.2970		0.3386	0.3426		0.3582	0.3715
MK	0.3197	0.3131	OK	0.3386	0.3235			
	0.3288	0.3282		0.3386	0.3426			
	0.3288	0.3081		0.3484	0.3571			
	0.3205	0.2956		0.3484	0.3388			
ML	0.3189	0.3302	OL	0.3386	0.3426			
	0.3288	0.3452		0.3386	0.3591			
	0.3288	0.3282		0.3484	0.3730			
	0.3197	0.3131		0.3484	0.3571			

Group Name on Label

Example: P1-FK

Brightness

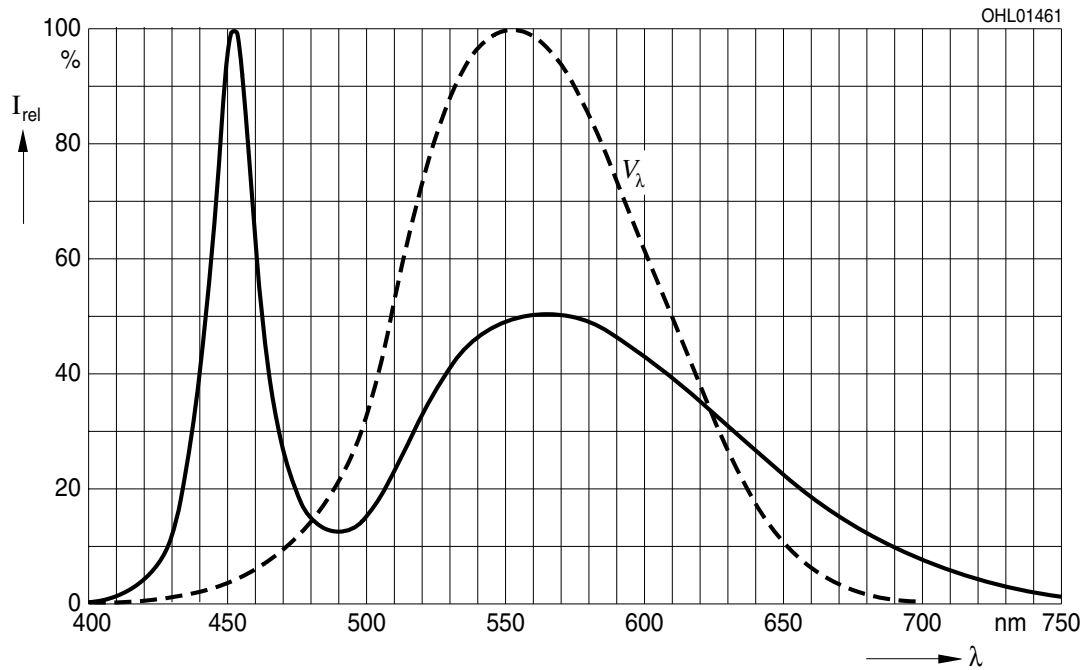
Color Chromaticity

P1

FK

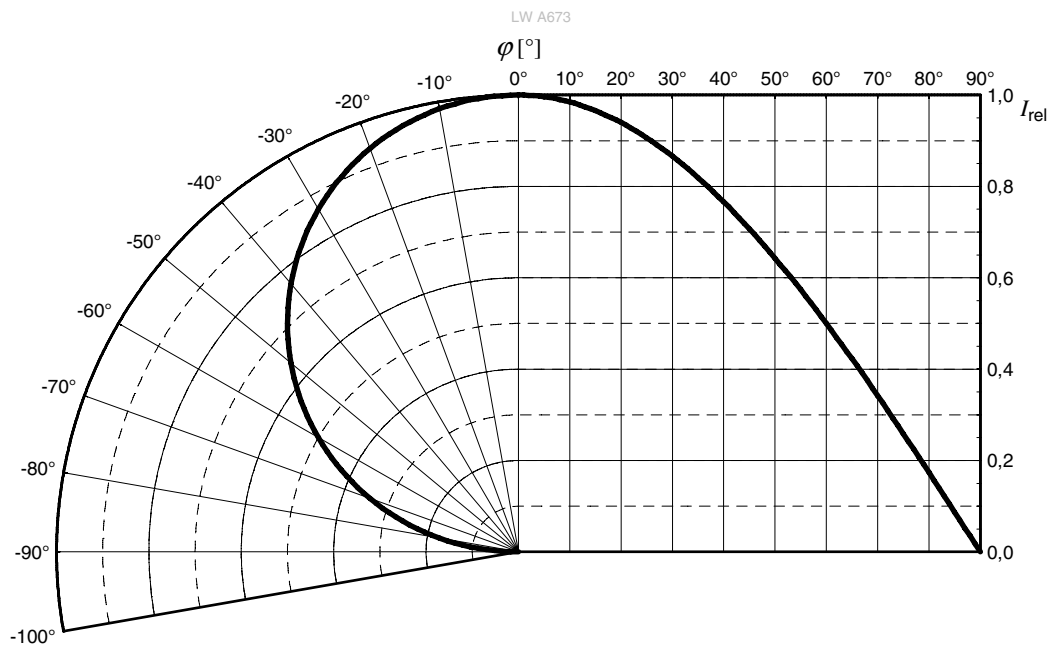
Relative Spectral Emission ⁷⁾

$I_{rel} = f(\lambda); I_F = 10 \text{ mA}; T_S = 25 \text{ }^\circ\text{C}$



Radiation Characteristics ⁷⁾

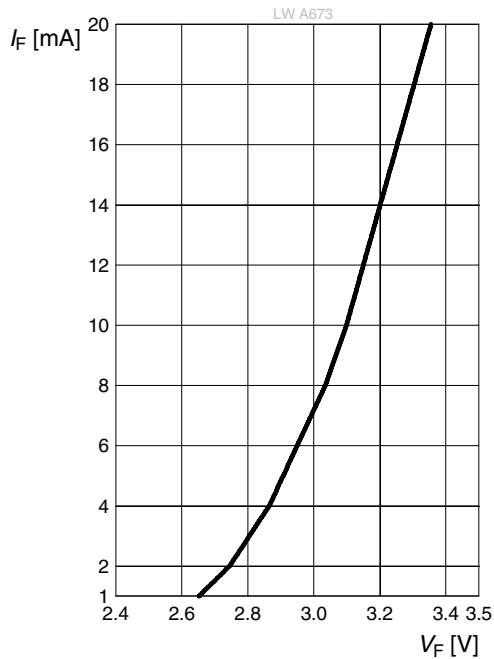
$I_{rel} = f(\phi); T_S = 25 \text{ }^\circ\text{C}$



Not for new design

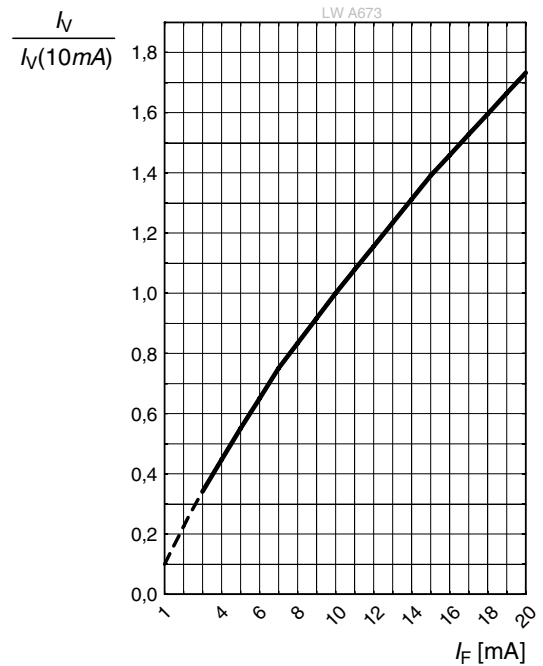
Forward current ⁷⁾

$$I_F = f(V_F); T_S = 25 \text{ }^\circ\text{C}$$



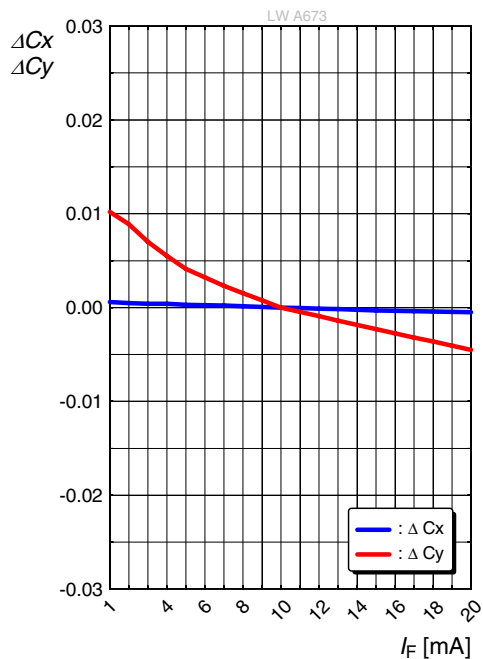
Relative Luminous Intensity ^{7), 8)}

$$I_V/I_V(10 \text{ mA}) = f(I_F); T_S = 25 \text{ }^\circ\text{C}$$



Chromaticity Coordinate Shift ⁷⁾

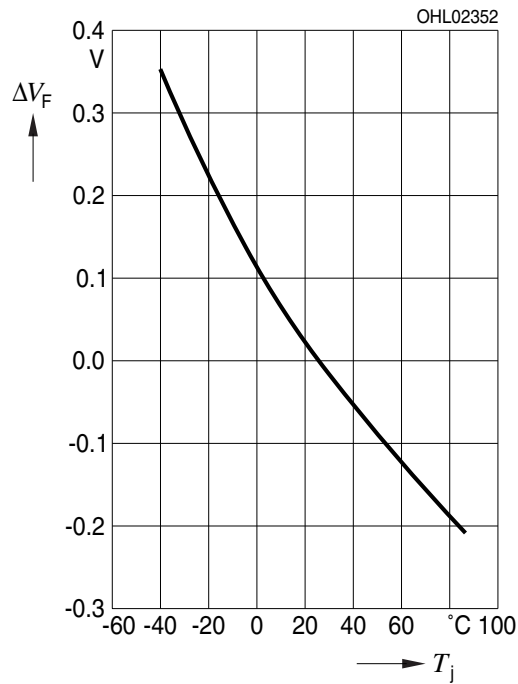
$$\Delta C_x, \Delta C_y = f(I_F); T_S = 25 \text{ }^\circ\text{C}$$



Not for new design

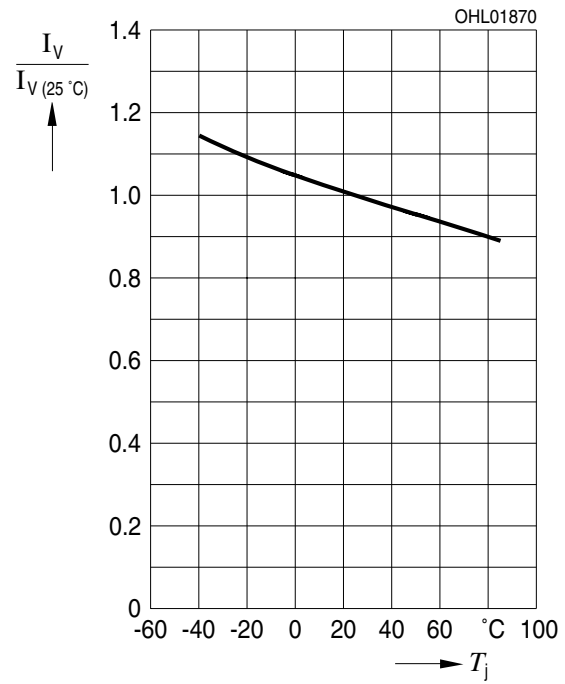
Forward Voltage ⁷⁾

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$



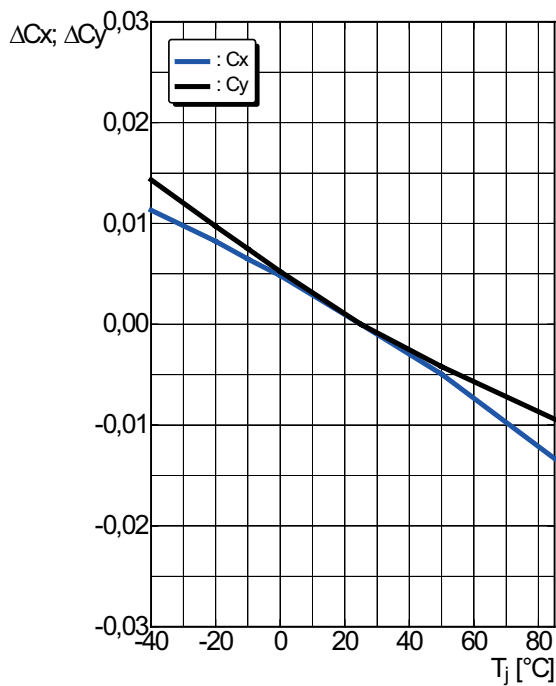
Relative Luminous Intensity ⁷⁾

$$I_V/I_V(25\text{ °C}) = f(T_j); I_F = 10\text{ mA}$$



Chromaticity Coordinate Shift ⁷⁾

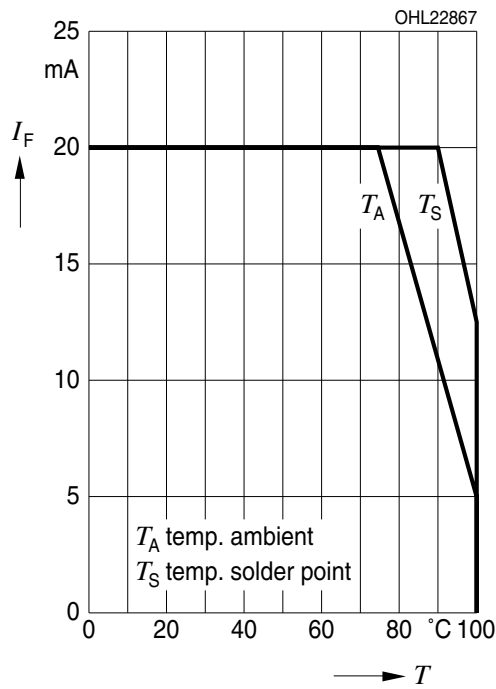
$$\Delta C_x, \Delta C_y = f(T_j); I_F = 10\text{ mA}$$



Not for new design

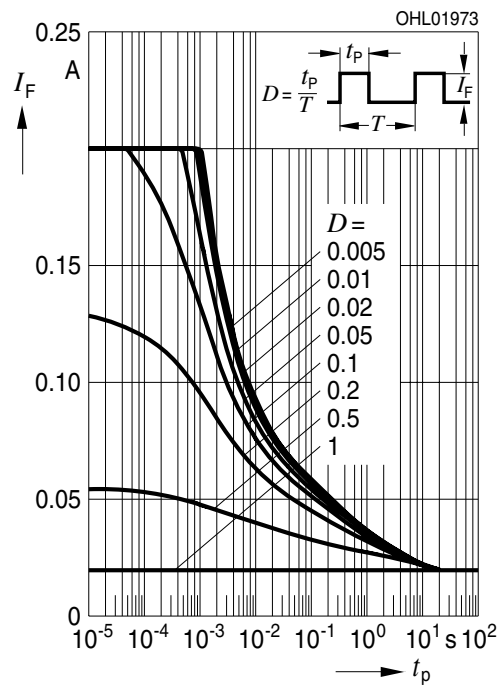
Max. Permissible Forward Current

$I_F = f(T)$



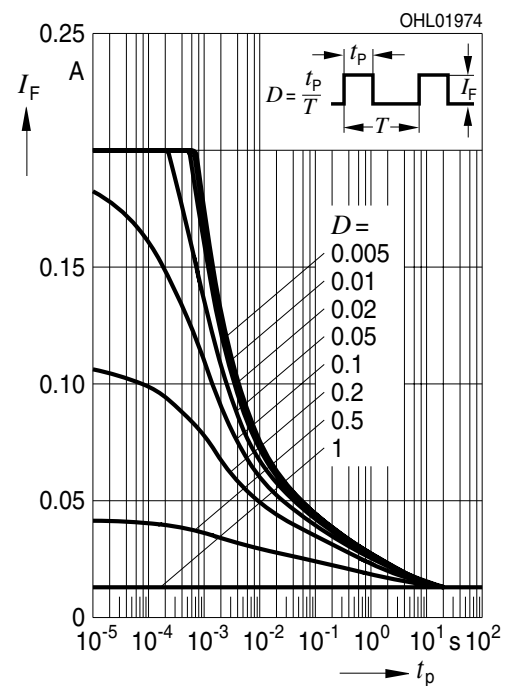
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_A = 25\text{ °C}$



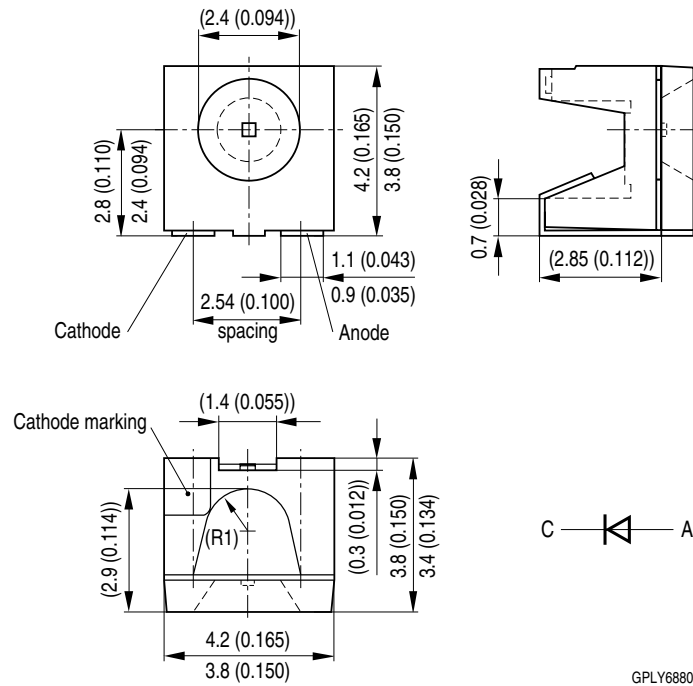
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_A = 85\text{ °C}$



Not for new design

Dimensional Drawing ⁹⁾

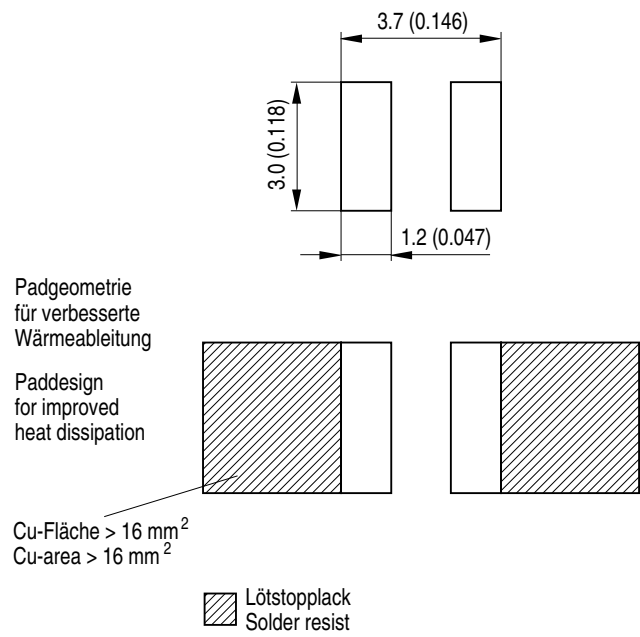


Further Information:

Approximate Weight: 67.0 mg

Corrosion test: Class: 3B
 Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

Recommended Solder Pad ⁹⁾

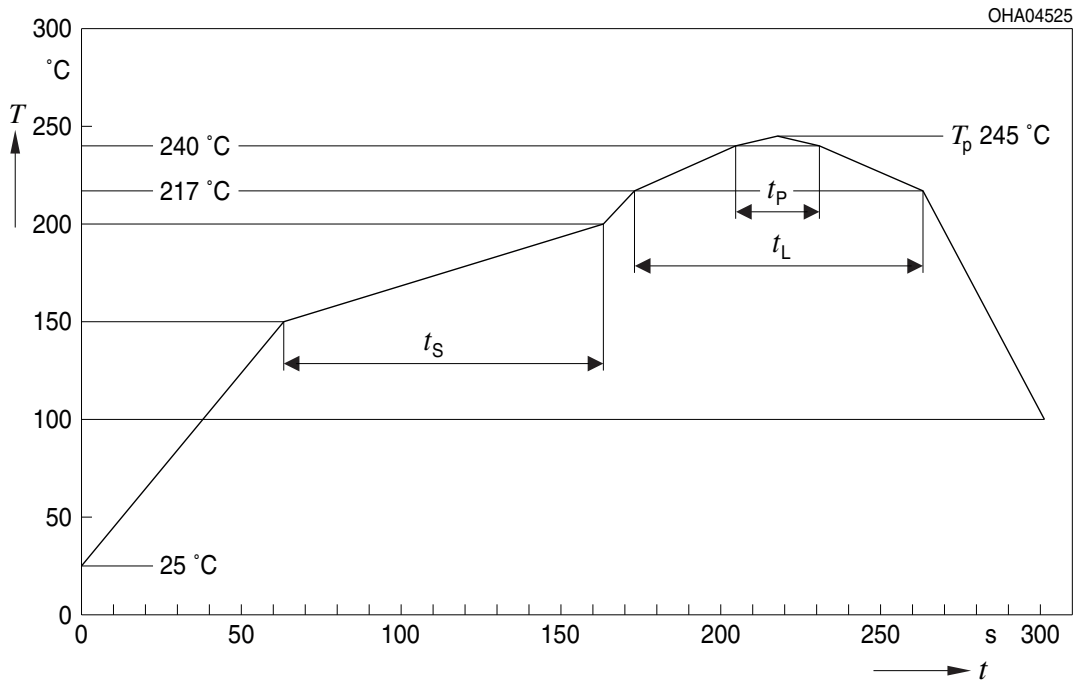


OHLPY965

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

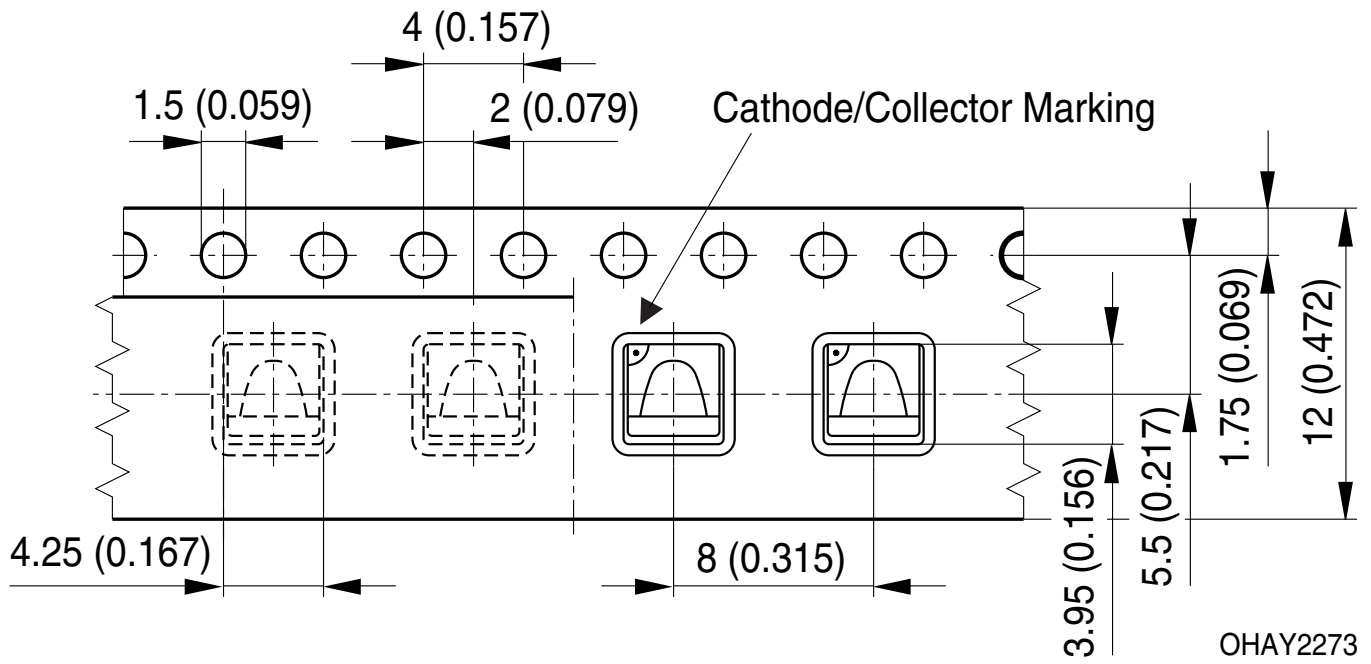


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	250	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	4	K/s
Time 25 °C to T_p				480	s

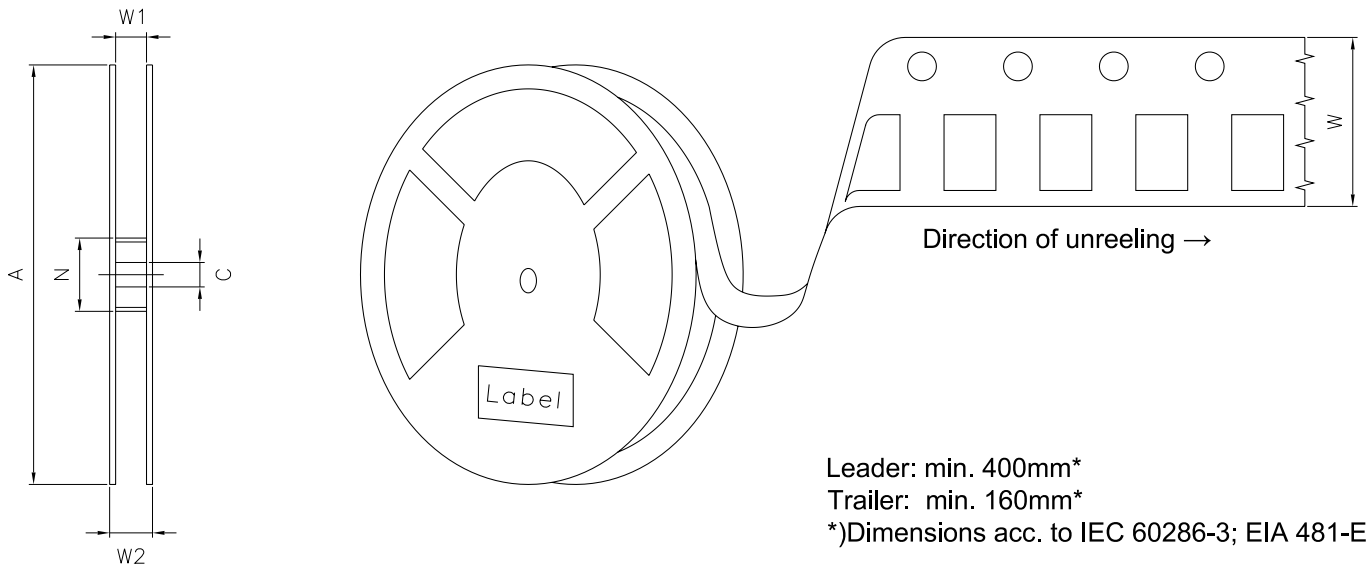
All temperatures refer to the center of the package, measured on the top of the component
 *) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Not for new design

Taping ⁹⁾



Tape and Reel ¹⁰⁾



Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

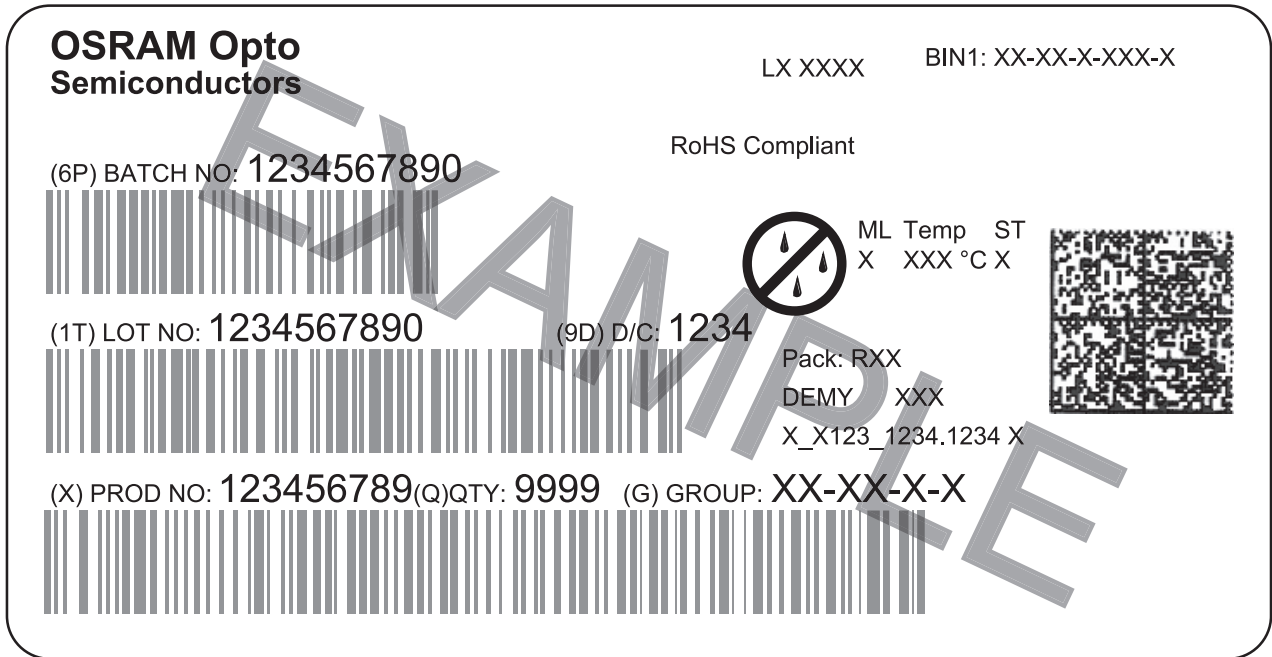
(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

ML Temp ST
X XXX °C X

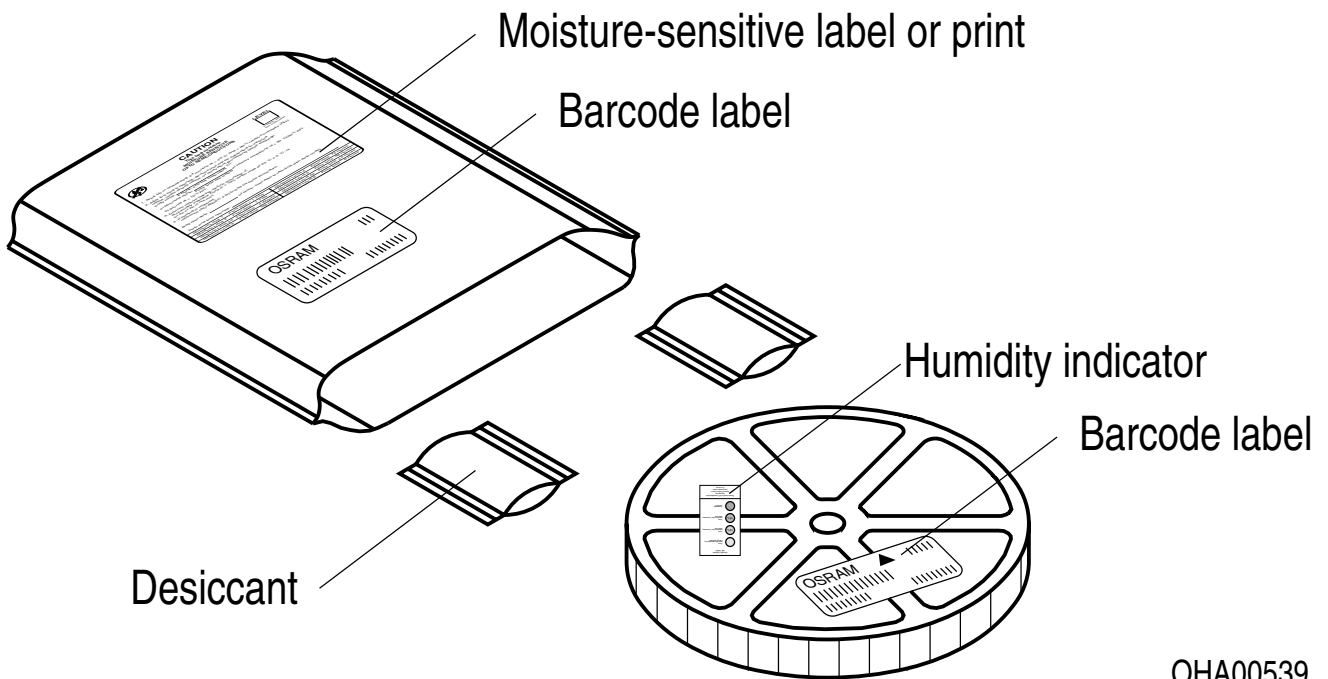
Pack: RXX
DEMY XXX
X_X123_1234.1234 X



The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is a 'RoHS Compliant' statement. The label features three main barcode sections: a top one for '(6P) BATCH NO: 1234567890', a middle one for '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234', and a bottom one for '(X) PROD NO: 123456789(Q)QTY: 9999' and '(G) GROUP: XX-XX-X-X'. To the right of the middle barcode is a 'No moisture' symbol (a circle with a diagonal line and three drops) and 'ML Temp ST X XXX °C X'. Further right is a square QR code. Below the QR code are 'Pack: RXX', 'DEMY XXX', and 'X_X123_1234.1234 X'. A large 'EXAMPLE' watermark is overlaid diagonally across the center.

OHA04563

Dry Packing Process and Materials ⁹⁾

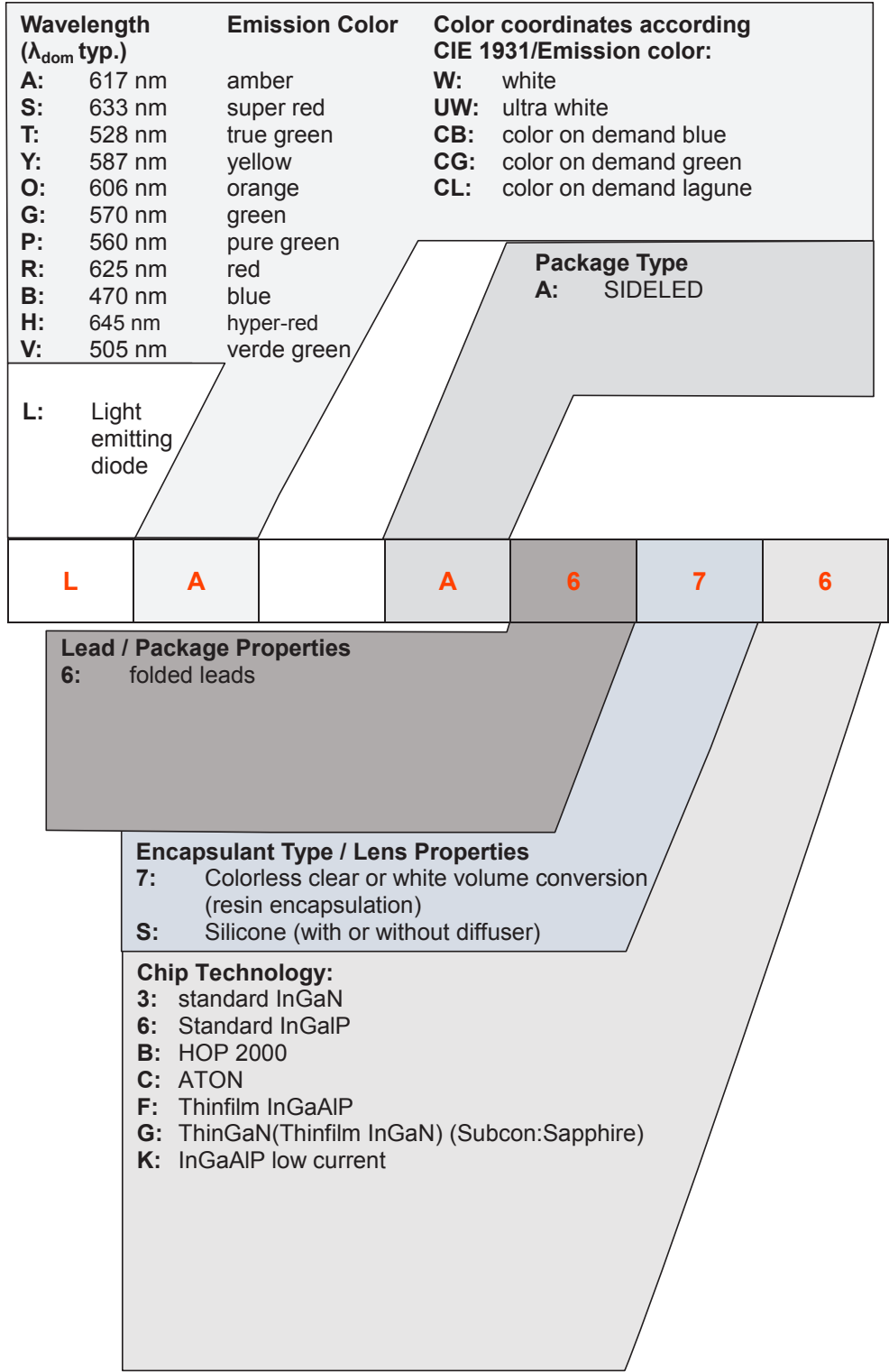


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Not for new design

Type Designation System



Not for new design

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Thermal Resistance:** R_{thJA} results from mounting on PC board FR 4 (pad size 16 mm² per pad)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.7	2020-09-21	Features Dry Packing Process and Materials Schematic Transportation Box

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按照中国的相关法规和标准，不含有毒有害物质或元素。

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

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- ⊖ [OSRAM Opto Semiconductors Inc. Information](#)

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- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management